

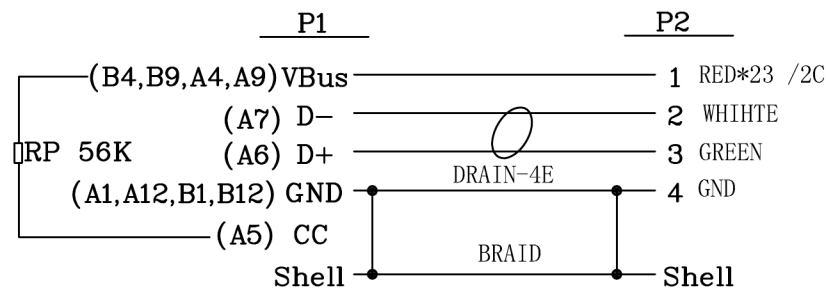
1. test conditions:

1. 100% of short circuit, open circuit test & dislocation.
2. Insulation impedance: 10M ohm (MIN) DC 300V.
3. Conduction impedance: 2 ohm (MAX).
4. Withstand voltage test: DC 300V/10ms

2. processing instructions:

1. C Type end was peeled 10 ~ 15 mm, outside order, in accordance with the thread gauge to conductor LiRu fixture groove (ground to twist In the GND PIN) weaving take 2 ~ 3 shares of twist in the Shell welding Pad, pay attention to the tin point should not be too large.
2. USB AM end and ground wire woven take 2 ~ 3 shares of twisting the welding on the GND Pad (lap plus tin soldering iron shell), pay attention to Tin not too big.
3. The P1 end after good conductor welding the PCB must be UV glue, UV glue dozen thin as far as possible,

4. Pin Assignment:



⑨	A0040411-00002	Low pressure molding compound, transparent color, hardness, 40 ~ 48 d	1	g
⑧	A0020100-00174	USB TYPE C On the tin plating nickel to clamp (one)	1	pcs
⑦	A0020100-00175	USB TYPE C The tin plating nickel to clamp (one)	1	pcs
⑥	A10-R075552	Heat shrinkable casing ~ φ 1.0mm ~ black	0.016	M
⑤	A5-R047107	45P WHITE PVC ROHS	16	g
④	A5-R047011	transparent PE ROHS LDPE	3	g
③	B010-01695	TYPE C- Connector With EMPTY PCB 56K resistance	1	pcs
②	A2-R029107	USB AM L=18.10MM WHITE INSULATION SHELL PLATED: NICKEL	1	pcs
①	A0010306-01279	23AWG(35/0.10TC+250DNylon)*2C+[28AWG(7/0.127TC)+A]*1P+30AWG(7/0.10TC)*1C+4E(19/0.10TC)+AB(16/9/0.06TC 70%)~OD:4.0MM-WHITE(PVC001-9002)-NO MARKING	3.0	M
NO		DESCRIPTION	Q'TY	UNIT

REV	ECN	DESCRIPTION	DATE	NAME
		TOLERANCE INCHES M/M		
	.X	.015 .30		
	.XX	.010 .10		
	.XXX	.005 .05		
DRAWN BY	zhouwenlong	CUSTOMER :	CPC	
CHECK BY		CUSTOMER P/N :	PSG91488	
APPD BY		SCALE	NONE	DRAWING NO.:
		UNIT	mm	REV. A01
		DATE	2017.05.03	C06026-00271 1/2

TITLE:
USB 2.0 AM TO CM L=3.0M